

● General Description

The AGM425MA combines advanced trench MOSFET technology with a low resistance package to provide extremely low $R_{DS(ON)}$.

This device is ideal for load switch and battery protection applications.

● Features

- Advance high cell density Trench technology
- Low $R_{DS(ON)}$ to minimize conductive loss
- Low Gate Charge for fast switching
- Low Thermal resistance

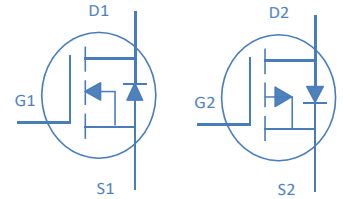
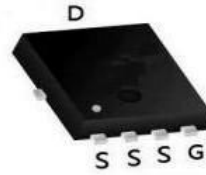
● Application

- MB/VGA Vcore
- SMPS 2nd Synchronous Rectifier
- POL application
- BLDC Motor driver

Product Summary

BVDSS	RDSON	ID
40V	18mΩ	23A
-40V	32mΩ	-20A

PDFN5*6 Pin Configuration



Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
AGM425MA	AGM425MA	PDFN5*6	--mm	--mm	3000

Table 1. Absolute Maximum Ratings ($T_A=25^\circ\text{C}$)

Symbol	Parameter	Rating		Units
		N-Ch	P-Ch	
V_{DS}	Drain-Source Voltage ($V_{GS}=0V$)	40	-40	V
V_{GS}	Gate-Source Voltage ($V_{DS}=0V$)	± 20	± 20	V
I_D	Drain Current-Continuous($T_c=25^\circ\text{C}$) ^(Note 1)	23	-20	A
	Drain Current-Continuous($T_c=100^\circ\text{C}$)	18	-12.6	A
IDM (pluse)	Drain Current-Continuous@ Current-Pulsed ^(Note 2)	46	-80	A
P_D	Total Power Dissipation($T_c=25^\circ\text{C}$)	25	27.8	W
	Total Power Dissipation($T_c=100^\circ\text{C}$)	10	11	W
EAS	Avalanche energy ^(Note 3)	28	18	mJ
T_J, T_{STG}	Operating Junction and Storage Temperature Range	-55 To 150	-55 To 150	$^\circ\text{C}$

Table 2. Thermal Characteristic

Symbol	Parameter	Typ	Max	Unit
$R_{\theta JA}$	Thermal Resistance Junction-ambient (Steady State) ¹	---	62	$^\circ\text{C/W}$
$R_{\theta JC}$	Thermal Resistance Junction-Case ¹	---	5	$^\circ\text{C/W}$

Table 3. N- Channel Electrical Characteristics (TA=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
On/Off States						
BVDSS	Drain-Source Breakdown Voltage	VGS=0V ID=250μA	40	--	--	V
IDSS	Zero Gate Voltage Drain Current	VDS=40V,VGS=0V	--	--	1	μA
IGSS	Gate-Body Leakage Current	VGS=±20V,VDS=0V	--	--	±100	nA
VGS(th)	Gate Threshold Voltage	VDS=VGS,ID=250μA	1.0	1.4	2.0	V
gFS	Forward Transconductance	VDS=5V,ID=10A	--	12	--	S
RDS(on)	Drain-Source On-State Resistance	VGS=10V, ID=15A	--	18	25	mΩ
		VGS=4.5V, ID=10A	--	25	33	mΩ
Dynamic Characteristics						
Ciss	Input Capacitance	VDS=15V,VGS=0V, F=1MHZ	--	593	--	pF
Coss	Output Capacitance		--	76	--	pF
Crss	Reverse Transfer Capacitance		--	56	--	pF
Rg	Gate resistance	VGS=0V, VDS=0V,f=1.0MHz	--	2.6	--	Ω
Switching Times						
td(on)	Turn-on Delay Time	VGS=10V,VDS=20V, ID=1A, RGEN=3.3Ω	--	8.9	--	nS
tr	Turn-on Rise Time		--	2.2	--	nS
td(off)	Turn-Off Delay Time		--	41	--	nS
tf	Turn-Off Fall Time		--	2.7	--	nS
Qg	Total Gate Charge	VGS=4.5V, VDS=12V, ID=20A	--	5.5	--	nC
Qgs	Gate-Source Charge		--	1.25	--	nC
Qgd	Gate-Drain Charge		--	2.5	--	nC
Source-Drain Diode Characteristics						
ISD	Source-Drain Current(Body Diode)		--	--	23	A
VSD	Forward on Voltage	VGS=0V,IS=1A	--	--	1.2	V
trr	Reverse Recovery Time	IF=1A , dI/dt=100A/μs ,	--	--	--	ns
Qrr	Reverse Recovery Charge	TJ=25°C	--	--	--	nc

Notes 1.The maximum current rating is package limited.

Notes 2.Repetitive Rating: Pulse width limited by maximum junction temperature

Notes 3.EAS condition: TJ=25°C

Table 3. P-Channel Electrical Characteristics (TA=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
On/Off States						
BVDSS	Drain-Source Breakdown Voltage	VGS=0V ID=-250μA	-40	--	--	V
IDSS	Zero Gate Voltage Drain Current	VDS=-40V,VGS=0V	--	--	-1	μA
IGSS	Gate-Body Leakage Current	VGS=±20V,VDS=0V	--	--	±100	nA
VGS(th)	Gate Threshold Voltage	VDS=VGS,ID=-250μA	-1.0	-1.5	-2.5	V
gFS	Forward Transconductance	VDS=-5V,ID=-10A	--	18	--	S
RDS(on)	Drain-Source On-State Resistance	VGS=-10V, ID=-15A	--	32	45	mΩ
		VGS=-4.5V, ID=-10A	--	41	52	mΩ
Dynamic Characteristics						
Ciss	Input Capacitance	VDS=-20V,VGS=0V, F=1MHZ	--	1080	--	pF
Coss	Output Capacitance		--	87	--	pF
Crss	Reverse Transfer Capacitance		--	77	--	pF
Rg	Gate resistance	VGS=0V, VDS=0V,f=1.0MHz	--	11	--	Ω
Switching Times						
td(on)	Turn-on Delay Time	VGS=-10V,VDS=-20V, ID=-6A,RGEN=3Ω	--	5.9	--	nS
tr	Turn-on Rise Time		--	7.1	--	nS
td(off)	Turn-Off Delay Time		--	25	--	nS
tf	Turn-Off Fall Time		--	8.2	--	nS
Qg	Total Gate Charge	VGS=-10V, VDS=-20V, ID=-6A	--	17	--	nC
Qgs	Gate-Source Charge		--	4.2	--	nC
Qgd	Gate-Drain Charge		--	3.7	--	nC
Source-Drain Diode Characteristics						
ISD	Source-Drain Current(Body Diode)		--	--	-20	A
VSD	Forward on Voltage	VGS=0V,IS=-6A	--	--	-1.2	V
trr	Reverse Recovery Time	IF=-6A , dl/dt=100A/μs , TJ=25°C	--	--	--	ns
Qrr	Reverse Recovery Charge		--	--	--	nc

Notes 1.The maximum current rating is package limited.

Notes2.Repetitive Rating: Pulse width limited by maximum junction temperature Notes

3.EAS condition: TJ=25°C

N-Channel Typical Characteristics

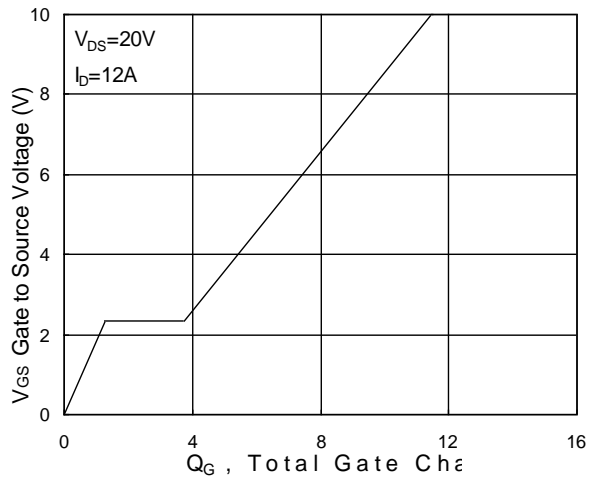
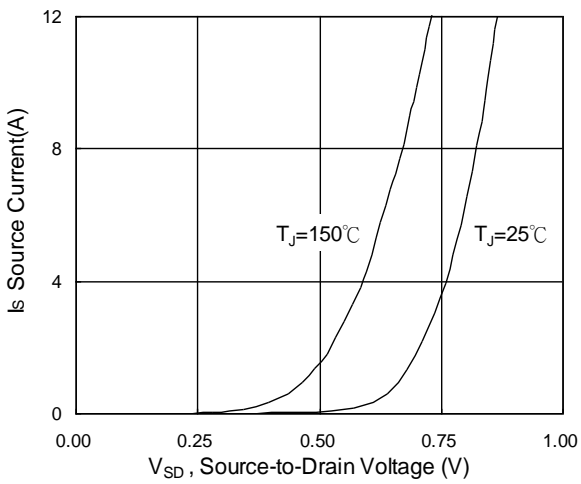
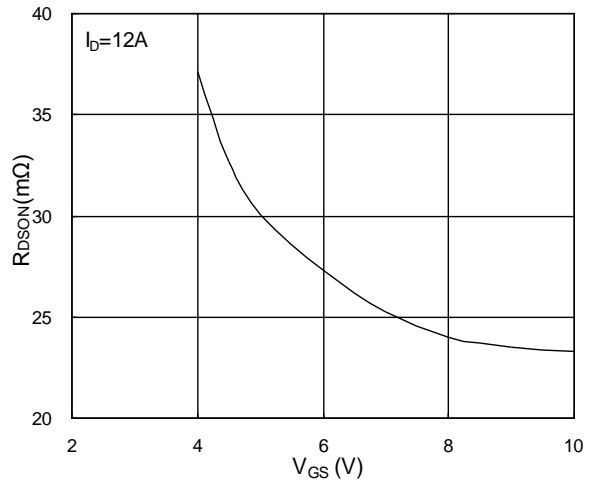
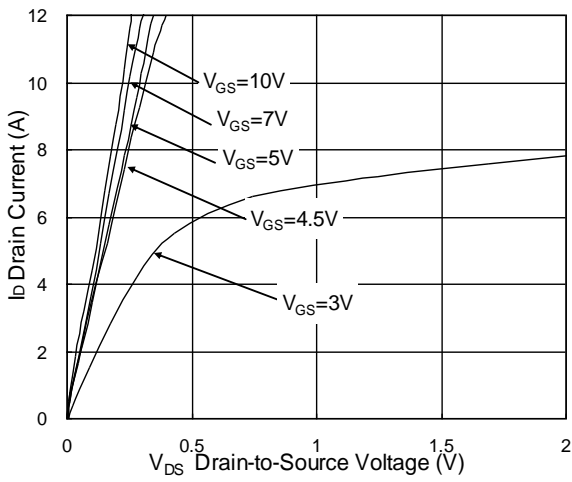


Fig 3 Forward Characteristics of Reverse

Fig 4 Gate-Charge Characteristics

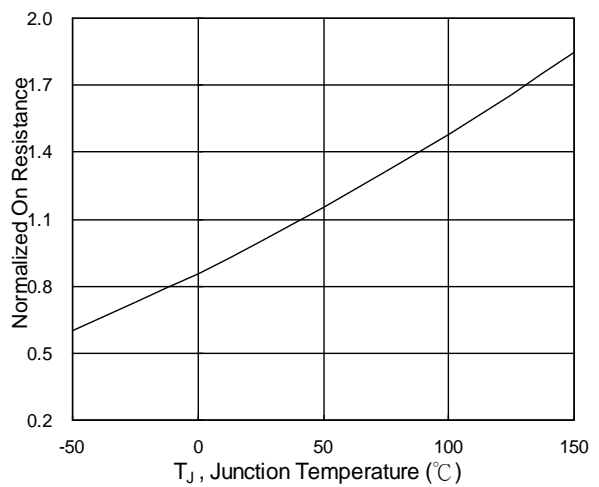
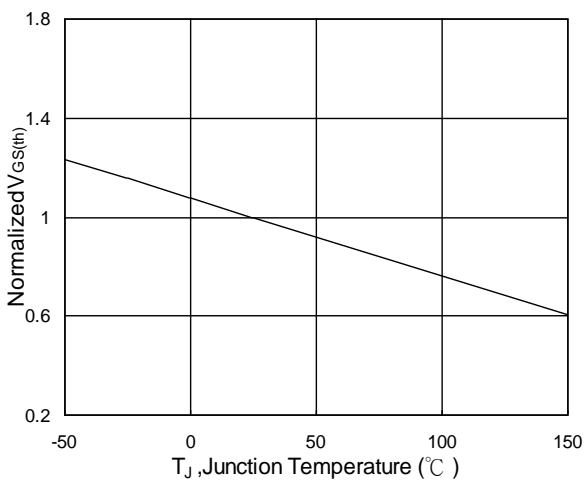


Fig.5 Normalized $V_{GS(th)}$ vs. T_J

Fig.6 Normalized $R_{DS(on)}$ vs. T_J

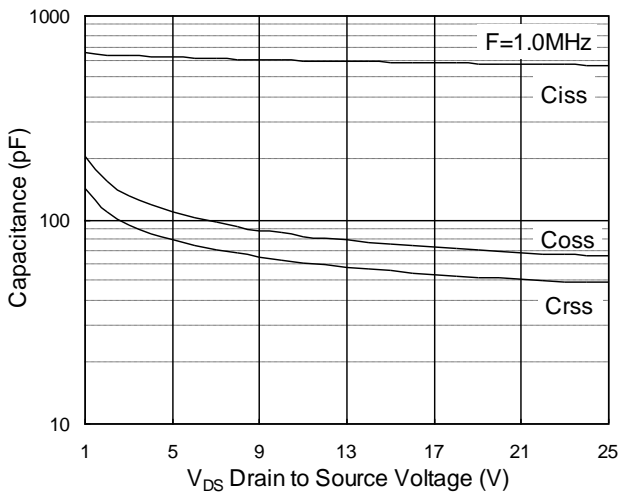


Fig.7 Capacitance

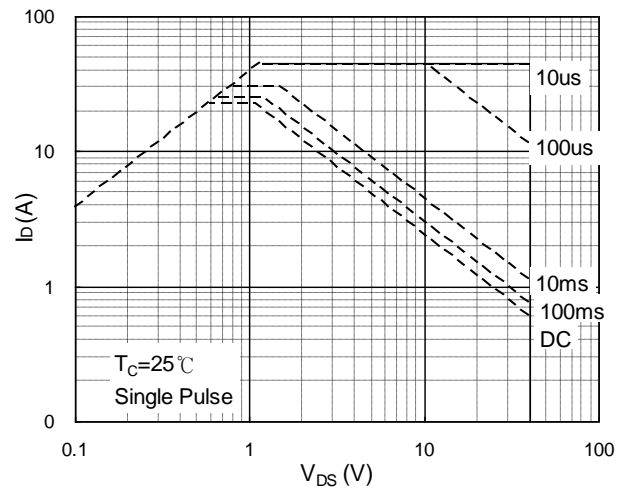


Fig.8 Safe Operating Area

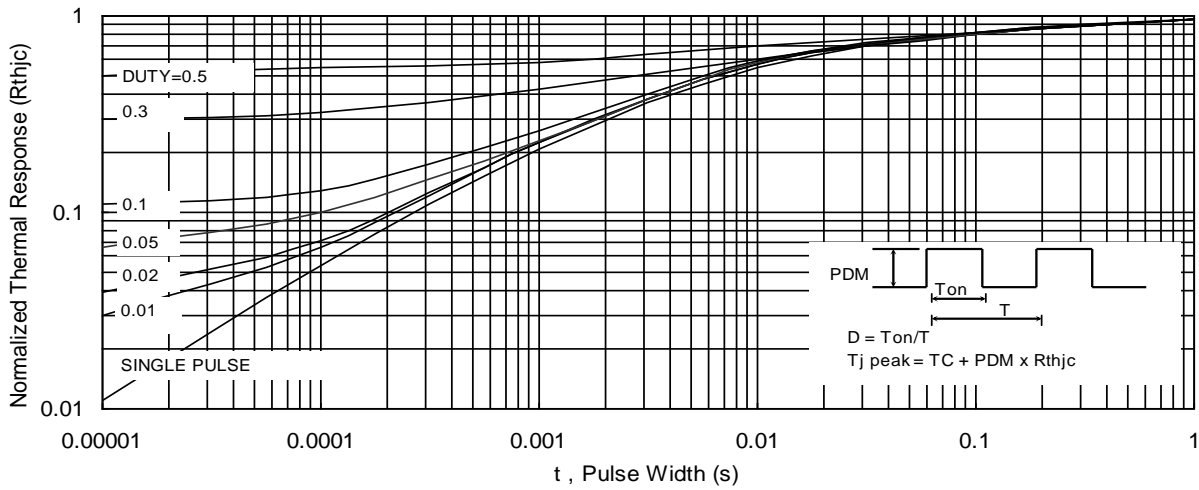


Fig.9 Normalized Maximum Transient Thermal Impedance

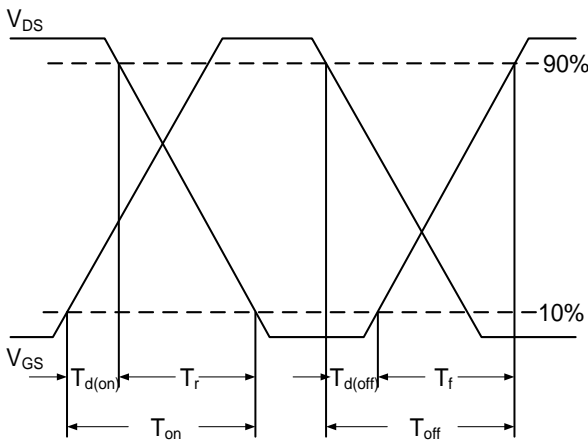


Fig.10 Switching Time Waveform

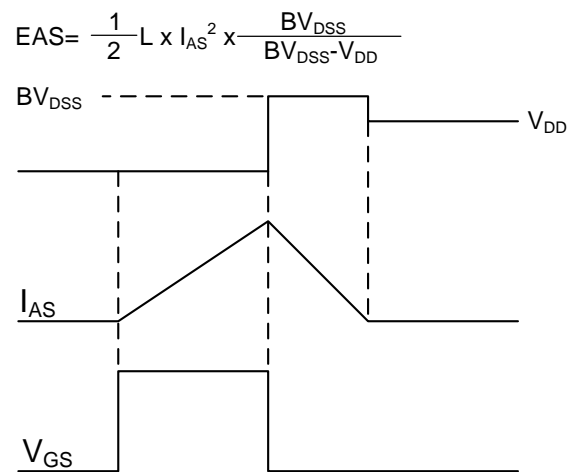
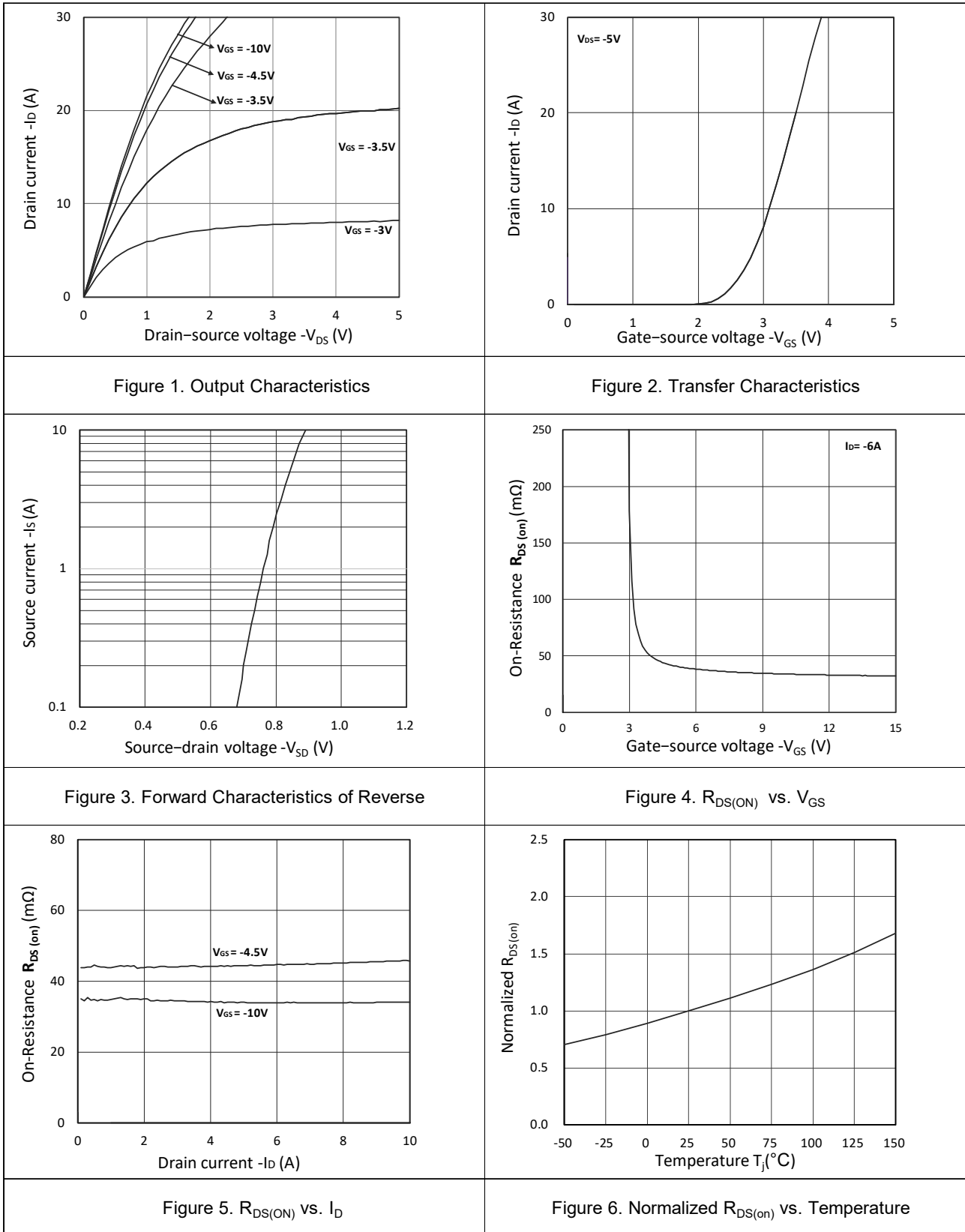


Fig.11 Unclamped Inductive Switching Wave

P-Channel Typical Characteristics



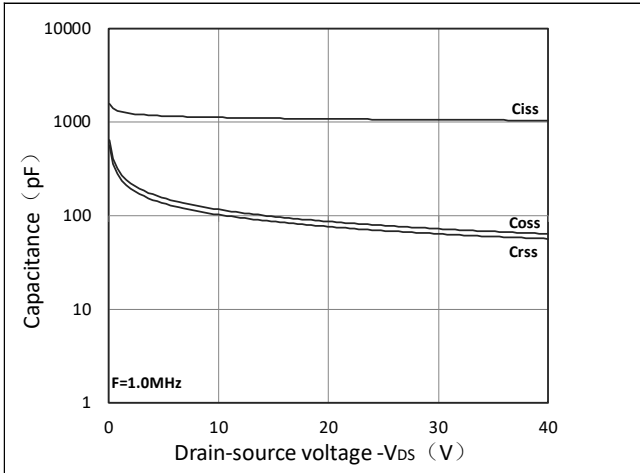


Figure 7. Capacitance Characteristics

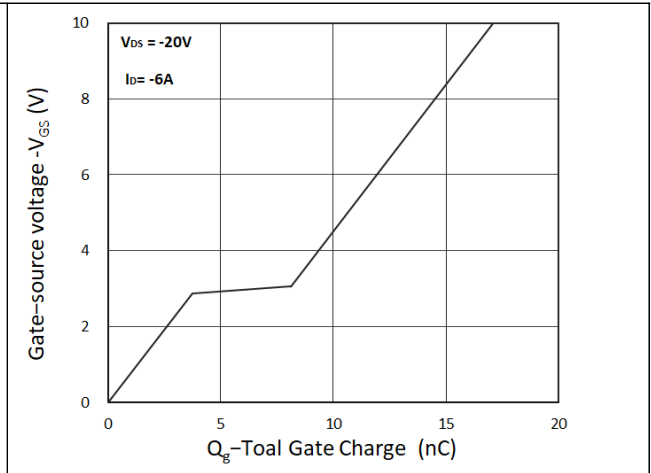


Figure 8. Gate Charge Characteristics

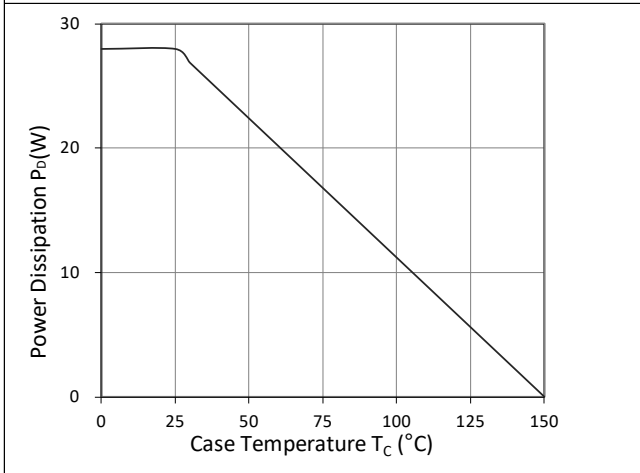


Figure 9. Power Dissipation

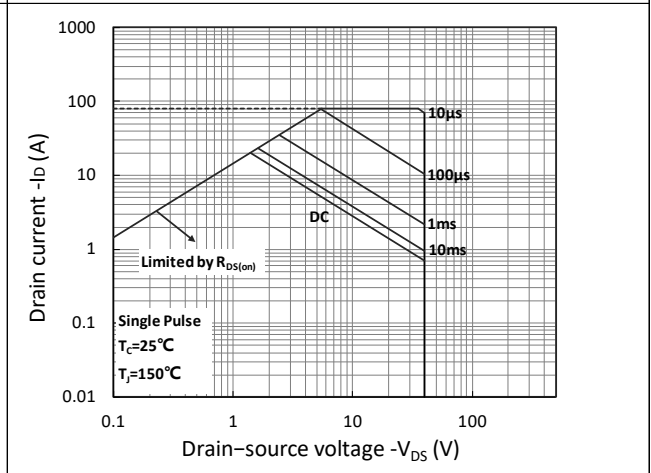


Figure 10. Safe Operating Area

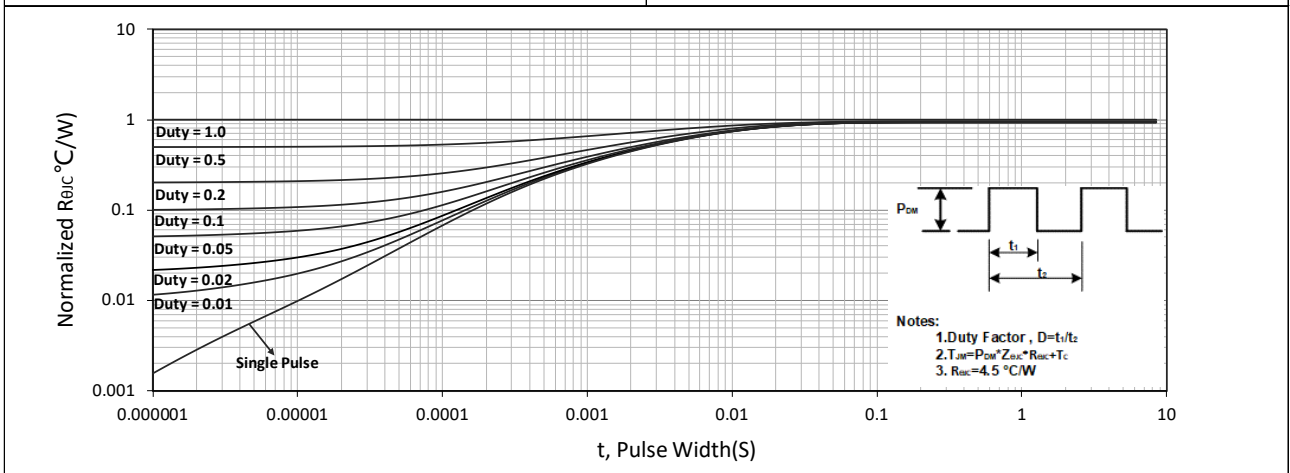


Figure 11. Normalized Maximum Transient Thermal Impedance

Test Circuit

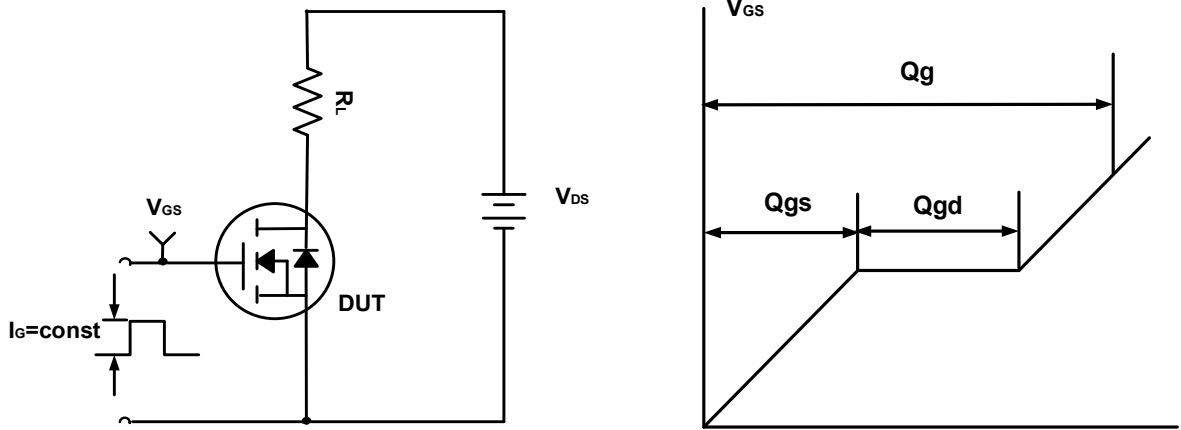


Figure A. Gate Charge Test Circuit & Waveforms

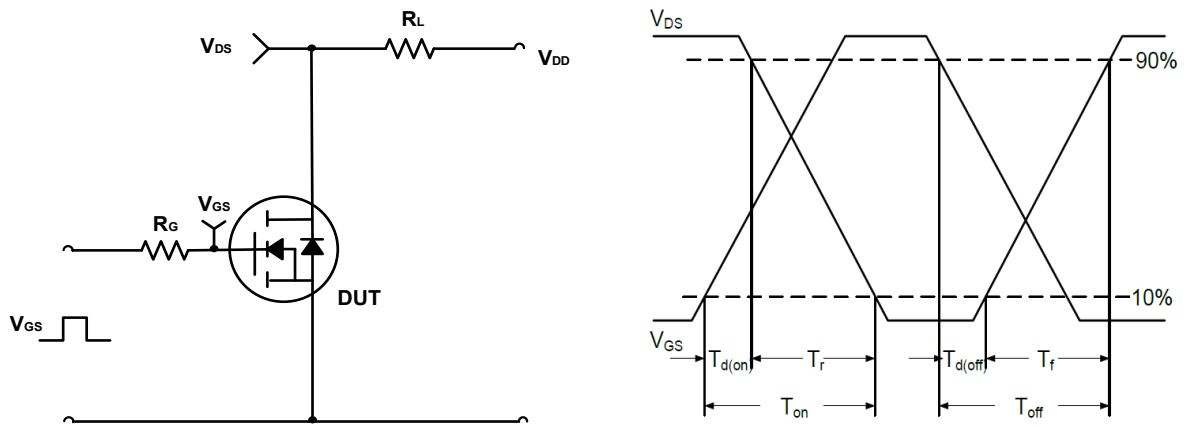


Figure B. Switching Test Circuit & Waveforms

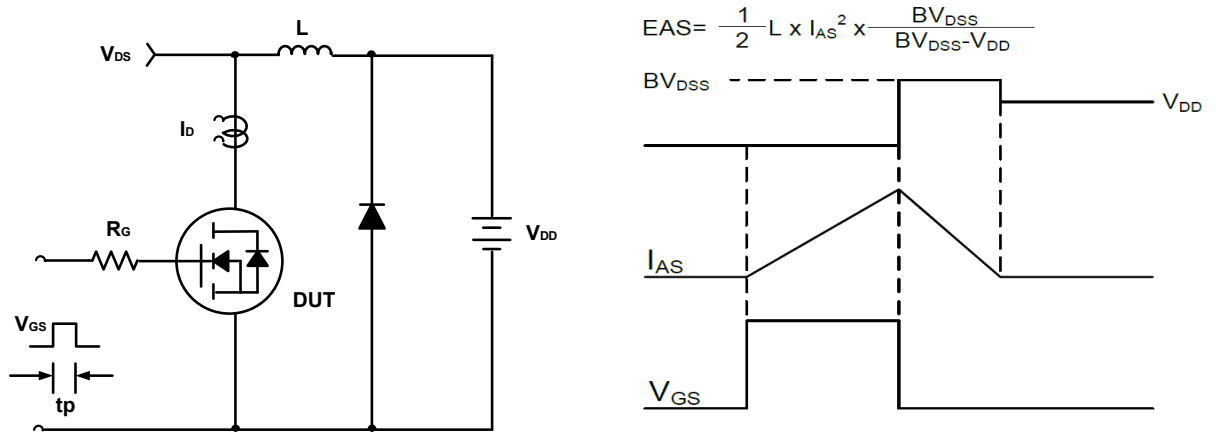
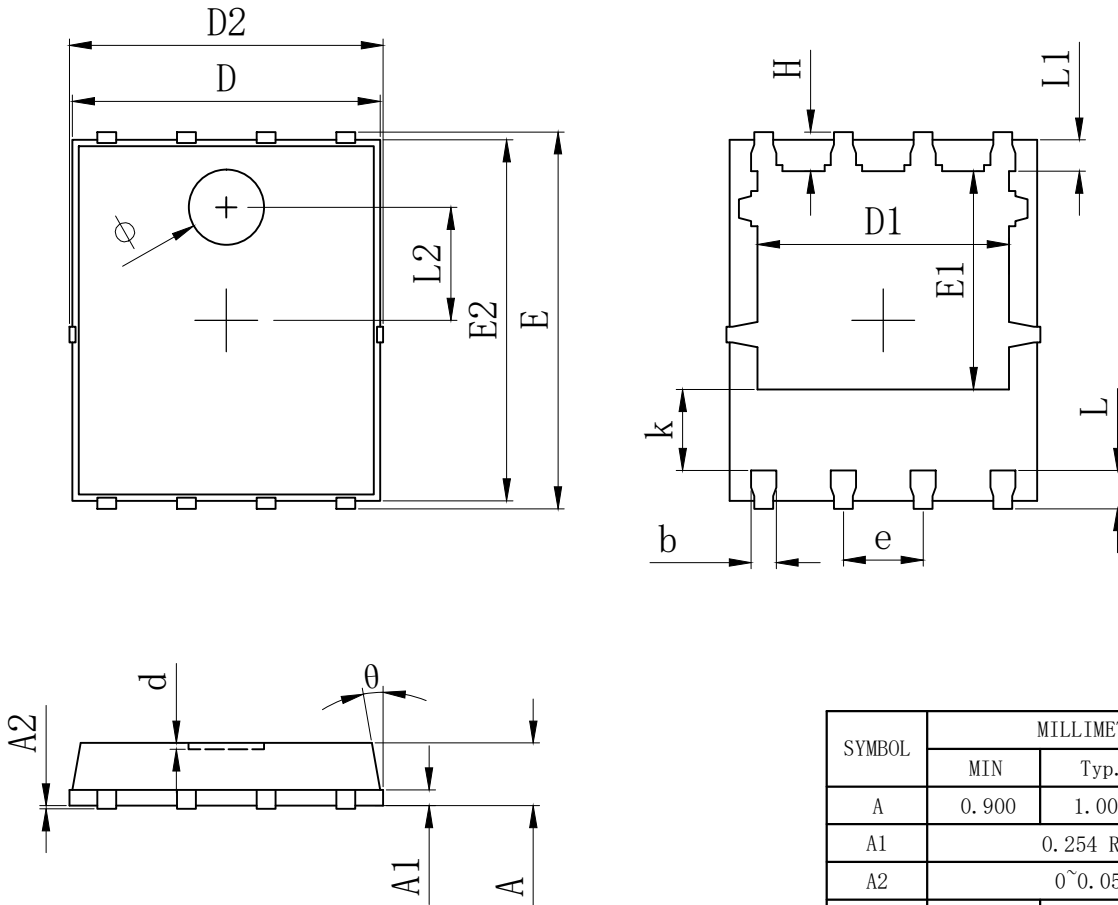


Figure C. Unclamped Inductive Switching Circuit & Waveforms

Dimensions:PDFN5*6



SYMBOL	MILLIMETER		
	MIN	Typ.	MAX
A	0.900	1.000	1.100
A1	0.254 REF.		
A2	0 ⁺ 0.05		
D	4.824	4.900	4.976
D1	3.910	4.010	4.110
D2	4.924	5.000	5.076
E	5.924	6.000	6.076
E1	3.375	3.475	3.575
E2	5.674	5.750	5.826
b	0.350	0.400	0.450
e	1.270 TYP.		
L	0.534	0.610	0.686
L1	0.424	0.500	0.576
L2	1.800 REF.		
k	1.190	1.290	1.390
H	0.549	0.625	0.701
θ	8°	10°	12°
ϕ	1.100	1.200	1.300
d			0.100


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